

UM1613 User manual

16-pin smartcard interface ST8034P demonstration board

Introduction

The purpose of this document is to describe, and provide information on, how to efficiently use the ST8034P smartcard interface device demonstration board.

The ST8034xx is a family of complete smartcard interface devices, compatible with ISO 7816, NDS and EMV™ 4.3 payment systems that provide selectable supply voltage for the smartcard with automatic deactivation sequence in case of overload, short-circuit or undervoltage, with programmable internal or external clock signal, reset signal and protected I/O data lines. The ST8034HC and ST8034C product variants also provide a chip select function that allows the device interface to be isolated from the microcontroller bus signals and to share the bus among multiple card interface devices in a parallel combination.

In summary, ST8034xx interface devices are placed between the smartcard and the microcontroller to provide all supply, protection, detection and control functions, with just minimum external components.



Figure 1. Demonstration board with card connector and microcontroller board interface

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Applications UM1613

1 Applications

Smartcard readers for

- Set-top boxes
- Pay-TV
- Identification
- Tachographs
- Banking

UM1613 Description

2 Description

Supply voltages terminals

ST8034P

Labeled test points on all signals

Card supply voltage smartcard connector

ST8034P smartcard interface device selection switch

Figure 2. Demonstration board description

2.1 Use of the demonstration board

The ST8034P demonstration board is designed both for standalone operation or to be fully controlled by the microcontroller; it is fully configurable and provides access to all the signals including supply voltages through labeled test points and uses a standard connector for a simple communication interface with the microcontroller block. The labeled test points on the board are in the same order as the signals in the flat interface cable.

For an easy connection of oscilloscope probes to the test points, remove the plastic tip with the hook from the probes and insert the center pin into the test point terminal. Ground test points are available in a sufficient amount throughout the board.

Card supply (V_{CC}) selection switch: the demonstration board provides easy but flexible card supply voltage selection either by the onboard configuration switch driving the tristate V_{CC} selection input pin VCC_SEL or by the microcontroller. Put the VCC_SEL switch to the position " $V_{DD(INTF)}$ " (logic high level) to select V_{CC} = 5 V or "GND" (logic low level) to select V_{CC} = 3.0 V, see *Table 1*, or to the center position ("MCU"/floating) which leaves this pin floating (i.e. selects V_{CC} = 1.8 V) and connects this signal to the microcontroller interface to allow its control of this input signal if the MCU is connected.

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VCC_SEL position	V _{CC}	
V _{DD(INTF)}	5 V	
MCU/floating	1.8 V or controlled by the microcontroller, if connected.	
GND	3.0 V	

Table 1. V_{CC} selection by tristate VCC_SEL switch

2.2 Smartcard interface

The demonstration board contains a full size smartcard connector. Insert the smartcard from the right-hand side, card contacts facing down. Card presence detection is implemented (a presence switch inside the card connector, normally open).

2.3 Interface to a microcontroller block

A standard 16-pin header connector with a standard cable is used to interconnect the ST8034P demonstration board module with a microcontroller block. The voltage level for communication on this interface is $V_{\rm DD(INTF)}$.

2.4 Default functionality notes

- No floating pins: for simple standalone testing, all the input signal levels are softly
 defined by pull-up or pull-down resistors on the board, refer to Figure 4: Schematic
 diagram.
- The PORADJ undervoltage threshold on the V_{DD(INTF)} supply voltage (UVLO) is set by R1 and R2 to 1.5 V typ. The resistors can be replaced with different values to set different undervoltage thresholds on V_{DD(INTF)}:

$$\begin{split} &V_{DD(INTF)} \text{ UVLO threshold (falling)} = (R1 + R2) / R2 \text{ x } V_{TH(PORADJ)} \\ &V_{DD(INTF)} \text{ UVLO threshold (rising)} = (R1 + R2) / R2 \text{ x } (V_{TH(PORADJ)} + V_{HYST(PORADJ)}) \\ &\text{For detailed specifications of the voltage threshold values, refer to Table 14 of the ST8034P datasheet.} \end{split}$$

The sum of R1 + R2 should be about 100 k Ω , which is a good compromise between a sufficient robustness and a minimum current consumption.

Please consider tolerance ranges of the resistors used in the resistor divider and specifications range of the $V_{TH(PORADJ)}$ to make sure that even in the worst case the real $V_{DD(INTF)}$ undervoltage deactivation threshold does not fall in the desired operating voltage range (i.e. consider also voltage supply tolerance range).

UM1613 Board layout

3 Board layout

3.1 Layout recommendations

The ST8034xx family of devices includes an LDO block to generate V_{CC} supply voltage for the smartcard, which (in contrast to previous ST8024/8024L devices with a charge pump) does not generate any noise and therefore even the requirements for a printed circuit board layout and external component selection are not so strict (general PCB layout rules apply). On the other hand, the LDO requires the input voltage (V_{DDP}) to be at least about 100 mV greater than the desired output voltage (V_{CC}) . Place the decoupling capacitors as close as possible to the appropriate pin of the ST8034 device and use sufficiently wide PCB tracks. Make the data and clock lines as short as possible and use a ground plane.

3.2 Component placement

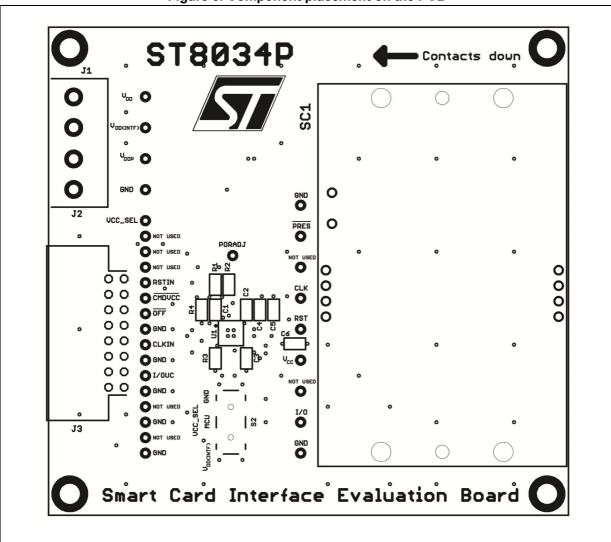


Figure 3. Component placement on the PCB

Schematic diagram UM1613

4 Schematic diagram

Figure 4. Schematic diagram W DOFF FCI7434L0825S01LF SMARTCARD 14 XD1-12 14 XD1-11 14 XD1-10 14 XD1-9 ₽₽ V CC CLK TO_SC1-4 1 XD8-GND ₽ B B R1 0 18 kΩ PORADJ 7 TO_SC1-8 PRES I/O GND CLK VCC_SEL TO_J3-15 2 6년 TO_J3-14 R4 🛮 100 kΩ XD1-4 XD1-2 XD1-1 VDD(INTF) MCU GND 명 R3 100 kΩ \$2G1 \$2G2 \$2G3 \$2G3 \$2G4 \$64 ARK210/2EX VDD VDDP XD3-GND ¥1
XD4-GND X1 XD6-GND > 1 XD7-GND > 1 XD5-GND 341 TO_J3-15
TO_J3-14
TO_J3-13
RSTIN
ICMDVCC TO_J3-4 VCC_SEL TO_J3-2 Nonc. J1 ARK210/2EX JCLKIN XD1-GND 1 4₽ H MLW16A

UM1613 Bill of material

5 Bill of material

Table 2. Bill of material

Component	Value	Type	Manufacturer	Note
U1	Smartcard interface device	ST8034PQR	STMicroelectronics [®]	QFN16 3 x 3 x 0.8 mm package
SC1	Smartcard connector	7434L0825S01LF	FCI	
J1	Power supply terminal	ARK210/2EX	Xinya	
J2	Power supply terminal ARK210/2EX Xinya			
J3	Header connector	T821116A1R100CEU	Amphenol	
S2	V _{CC} selection switch	SSSS820501	ALPS	
R1	18 kΩ	0805		
R2	82 kΩ	0805		
R3	100 kΩ	0805		
R4	100 kΩ	0805		
C1	100 nF	0805		
C2	100 nF	0805		
С3	100 nF	0805		
C4	100 nF	0805		
C5	10 μF	0805		
C6	220 nF	0805		
Cable connectors	2 x 8 pin / 16-lead	T812116A101CEU	Amphenol	
Cable	16-lead	1-57040-6	TE Connectivity	

Revision history UM1613

6 Revision history

Table 3. Document revision history

Date	Revision	Changes
27-Aug-2013	1	Initial release.

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